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APPLICANT: SANYO ELECTRIC CO LTD;

INVENTOR: AOYAMA MASASHIGE;

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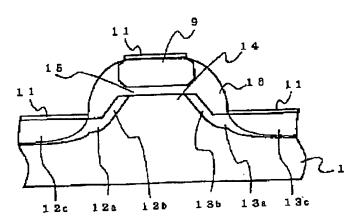
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TITLE

: SEMICONDUCTOR DEVICE AND ITS

MANUFACTURE



ABSTRACT: PROBLEM TO BE SOLVED: To obtain a semiconductor device which can be driven at a high speed, while the occurrence of a short channel effect is suppressed even if the device is made finer.

> SOLUTION: Since a semiconductor device has a structure such that a source region 12 and a drain region 13 are bent toward a gate electrode 9, with the regions 12 and 13 being partially protruded, the regions of the source and drain regions 12 and 13 facing the gate electrode 9 become smaller, and the parasitic capacitances between the gate electrode 9 and the source and the drain regions 12 and 13 can be reduced. In addition, since the impurity concentrations in the protruded sections are lower, no wide space-charge region is formed around the protruded sections. Therefore, the occurrence of a short-channel effect can be prevented.

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